

TLP2160

1. Applications

- Factory Networking
- High-Speed Digital Interfacing for Instrumentation and Control Devices
- Plasma Display Panels (PDPs)

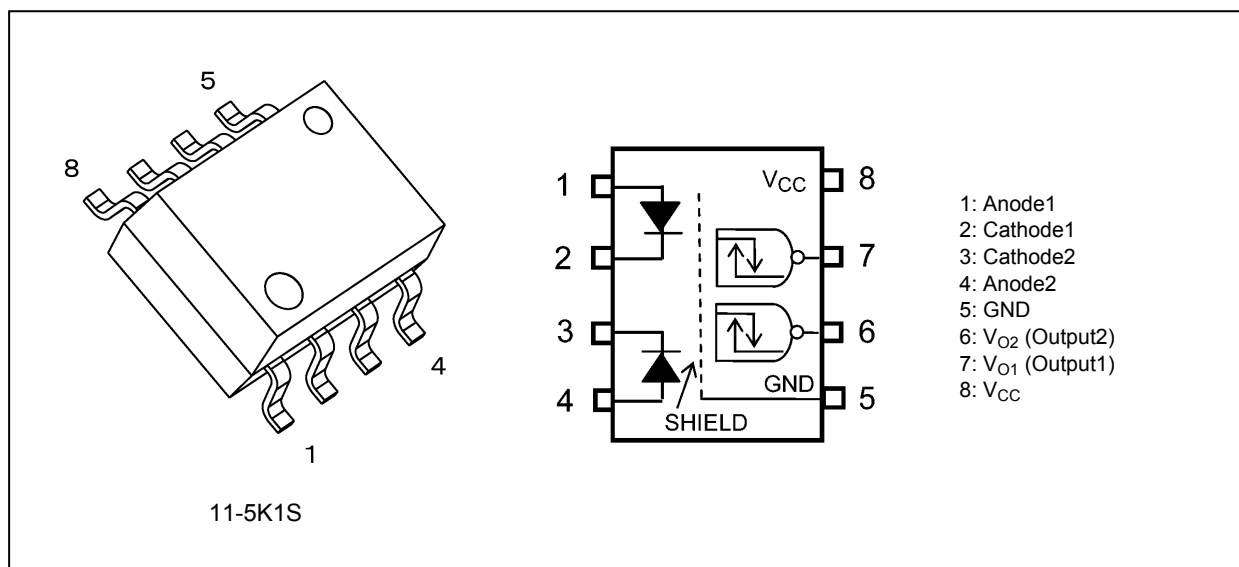
2. General

The Toshiba TLP2160 consists of a high-output infrared LED coupled with a high-speed photo IC chip. TLP2160 guarantees operation at up to 125°C and on supplies from 2.7 V to 5.5 V. It is offered in the SO8 package. It has a totem-pole output that can both sink and source current. With two LED-photoreceptor pairs, the TLP2160 helps save board space. An internal noise shield provides a guaranteed common-mode transient immunity of 20 kV/μs.

3. Features

- (1) Inverter logic type (totem pole output)
 - (2) Package: SO8
 - (3) Operating temperature range: -40 to 125 °C
 - (4) Supply voltage: 2.7 to 5.5 V
 - (5) Data transfer rate: 20 MBd (typ.) (NRZ)
 - (6) Threshold input current: 3.5 mA (max)
 - (7) Supply current: 5 mA (max)
 - (8) Common-mode transient immunity: ±20 kV/μs (min)
 - (9) Isolation voltage: 2500 Vrms (min)
 - (10) Safety standards
 - UL-recognized: UL 1577, File No.E67349
 - cUL-recognized: CSA Component Acceptance Service No.5A File No.E67349
 - VDE-approved: EN 60747-5-5 (**Note 1**)
- Note 1: When a VDE approved type is needed, please designate the **Option (V4)**.

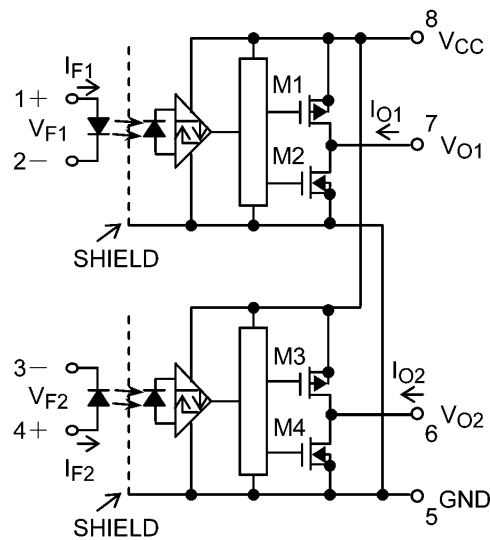
4. Packaging and Pin Assignment



Start of commercial production

2011-03

5. Internal Circuit (Note)



Note: A 0.1-μF bypass capacitor must be connected between pin 8 and pin 5.

6. Principle of Operation

6.1. Truth Table

Input	LED1(2)	M1(3)	M2(4)	Output1(2)
H	ON	OFF	ON	L
L	OFF	ON	OFF	H

6.2. Mechanical Parameters

Characteristics	Min	Unit
Creepage distances	4.2	mm
Clearance distances	4.2	
Internal isolation thickness	—	

7. Absolute Maximum Ratings (Note) (Unless otherwise specified, $T_a = 25\text{ }^{\circ}\text{C}$)

	Characteristics	Symbol	Note	Rating	Unit
LED	Input forward current	I_F	(Note 1)	25	mA
	Input forward current derating ($T_a \geq 110\text{ }^{\circ}\text{C}$)	$\Delta I_F / \Delta T_a$	(Note 1)	-0.67	mA/ $^{\circ}\text{C}$
	Input forward current (pulsed)	I_{FP}	(Note 1), (Note 2)	40	mA
	Input forward current derating (pulsed) ($T_a \geq 110\text{ }^{\circ}\text{C}$)	$\Delta I_{FP} / \Delta T_a$	(Note 1)	-1.0	mA/ $^{\circ}\text{C}$
	Input power dissipation	P_D	(Note 1)	40	mW
	Input power dissipation derating ($T_a \geq 110\text{ }^{\circ}\text{C}$)	$\Delta P_D / \Delta T_a$	(Note 1)	-1.0	mW/ $^{\circ}\text{C}$
	Input reverse voltage	V_R	(Note 1)	5	V
Detector	Output current	I_O	(Note 1)	10	mA
	Output voltage	V_O	(Note 1)	6	V
	Supply voltage	V_{CC}		6	
	Output power dissipation	P_O	(Note 1)	60	mW
	Output power dissipation derating ($T_a \geq 110\text{ }^{\circ}\text{C}$)	$\Delta P_O / \Delta T_a$	(Note 1)	-1.5	mW/ $^{\circ}\text{C}$
Common	Operating temperature	T_{opr}		-40 to 125	$^{\circ}\text{C}$
	Storage temperature	T_{stg}		-55 to 150	
	Lead soldering temperature (10 s)	T_{sol}		260	
	Isolation voltage (AC, 60 s, R.H. $\leq 60\%$)	BV_S	(Note 3)	2500	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

Note 1: Each channel

Note 2: Pulse width (PW) $\leq 1\text{ ms}$, duty = 50 %

Note 3: This device is considered as a two-terminal device: Pins 1, 2, 3 and 4 are shorted together, and pins 5, 6, 7 and 8 are shorted together.

8. Recommended Operating Conditions (Note)

Characteristics	Symbol	Note	Min	Typ.	Max	Unit
Input on-state current	$I_{F(ON)}$	(Note 1), (Note 2)	4.5	—	15	mA
Input off-state voltage	$V_{F(OFF)}$	(Note 1)	0	—	0.8	V
Supply voltage	V_{CC}	(Note 3)	2.7	3.3 / 5	5.5	
Operating temperature	T_{opr}	(Note 3)	-40	—	125	$^{\circ}\text{C}$

Note: The recommended operating conditions are given as a design guide necessary to obtain the intended performance of the device. Each parameter is an independent value. When creating a system design using this device, the electrical characteristics specified in this data sheet should also be considered.

Note: A ceramic capacitor (0.1 μF) should be connected between pin 8 and pin 5 to stabilize the operation of a high-gain linear amplifier. Otherwise, this photocoupler may not switch properly. The bypass capacitor should be placed within 1 cm of each pin.

Note 1: Each channel

Note 2: The rise and fall times of the input on-current should be less than 0.5 μs .

Note 3: Denotes the operating range, not the recommended operating condition.

9. Electrical Characteristics (Note) (Unless otherwise specified, $T_a = -40$ to $125\text{ }^{\circ}\text{C}$, $V_{CC} = 2.7$ to 5.5 V)

Characteristics	Symbol	Note	Test Circuit	Test Condition	Min	Typ.	Max	Unit
Input forward voltage	V_F	(Note 1)		$I_F = 10\text{ mA}$, $T_a = 25\text{ }^{\circ}\text{C}$	1.45	1.55	1.7	V
Input forward voltage temperature coefficient	$\Delta V_F / \Delta T_a$	(Note 1)		$I_F = 10\text{ mA}$	—	-2.0	—	mV/ $^{\circ}\text{C}$
Input reverse current	I_R	(Note 1)		$V_R = 5\text{ V}$, $T_a = 25\text{ }^{\circ}\text{C}$	—	—	10	μA
Input capacitance	C_t	(Note 1)		$V = 0\text{ V}$, $f = 1\text{ MHz}$, $T_a = 25\text{ }^{\circ}\text{C}$	—	60	—	pF
Low-level output voltage	V_{OL}	(Note 1)	Fig. 12.1.1	$I_F = 14\text{ mA}$, $I_O = 4\text{ mA}$	—	—	0.4	V
High-level output voltage	V_{OH}	(Note 1)	Fig. 12.1.2	$V_F = 1.05\text{ V}$, $I_O = -4\text{ mA}$, $V_{CC} = 3.3\text{ V}$	2.3	—	—	V
				$V_F = 1.05\text{ V}$, $I_O = -4\text{ mA}$, $V_{CC} = 5\text{ V}$	4	—	—	
Low-level supply current	I_{CCL}		Fig. 12.1.3	$I_{F1} = I_{F2} = 14\text{ mA}$	—	—	5	mA
High-level supply current	I_{CCH}		Fig. 12.1.4	$I_{F1} = I_{F2} = 0\text{ mA}$	—	—	5	
Threshold input current (H/L)	I_{FHL}	(Note 1)		$I_O = 1.6\text{ mA}$, $V_O < 0.4\text{ V}$	—	—	3.5	

Note: All typical values are at $V_{CC} = 5.0\text{ V}$, $T_a = 25\text{ }^{\circ}\text{C}$.

Note 1: Each channel

10. Isolation Characteristics (Unless otherwise specified, $T_a = 25\text{ }^{\circ}\text{C}$)

Characteristics	Symbol	Note	Test Condition	Min	Typ.	Max	Unit
Total capacitance (input to output)	C_S	(Note 1)	$V = 0\text{ V}$, $f = 1\text{ MHz}$	—	0.8	—	pF
Isolation resistance	R_S	(Note 1)	$V = 500\text{ V}$, R.H. $\leq 60\%$	10^{12}	10^{14}	—	Ω
Isolation voltage	BV_S	(Note 1)	AC, 60 s	2500	—	—	Vrms

Note 1: This device is considered as a two-terminal device: Pins 1, 2, 3 and 4 are shorted together, and pins 5, 6, 7 and 8 are shorted together.

11. Switching Characteristics (Note)

11.1. Switching Characteristics (1)

(Unless otherwise specified, $T_a = -40$ to $125\text{ }^{\circ}\text{C}$, $V_{CC} = 2.7$ to 3.6 V)

Characteristics	Symbol	Note	Test Circuit	Test Condition	Min	Typ.	Max	Unit
Propagation delay time (H/L)	t_{pHL}	(Note 1)	Fig. 12.1.5	$I_F = 0 \rightarrow 14\text{ mA}$, $R_{IN} = 100\text{ }\Omega$, $C_L = 15\text{ pF}$	—	30	40	ns
Propagation delay time (L/H)	t_{pLH}	(Note 1)		$I_F = 14 \rightarrow 0\text{ mA}$, $R_{IN} = 100\text{ }\Omega$, $C_L = 15\text{ pF}$	—	25	40	
Pulse width distortion	$ t_{pHL} - t_{pLH} $	(Note 1)		$I_F = 14\text{ mA}$, $R_L = 100\text{ }\Omega$, $C_L = 15\text{ pF}$	—	5	25	ns
Propagation delay skew (device to device)	t_{psk}	(Note 1), (Note 2)		$I_F = 14\text{ mA}$, $R_{IN} = 100\text{ }\Omega$, $C_L = 15\text{ pF}$	-30	—	30	ns
Propagation delay time (H/L)	t_{pHL}	(Note 1)	Fig. 12.1.5	$I_F = 0 \rightarrow 6\text{ mA}$, $R_{IN} = 100\text{ }\Omega$, $C_L = 15\text{ pF}$	—	36	55	ns
Propagation delay time (L/H)	t_{pLH}	(Note 1)		$I_F = 6 \rightarrow 0\text{ mA}$, $R_{IN} = 100\text{ }\Omega$, $C_L = 15\text{ pF}$	—	26	55	
Pulse width distortion	$ t_{pHL} - t_{pLH} $	(Note 1)		$I_F = 6\text{ mA}$, $R_{IN} = 100\text{ }\Omega$, $C_L = 15\text{ pF}$	—	10	30	ns
Propagation delay skew (device to device)	t_{psk}	(Note 1), (Note 2)		$I_F = 6\text{ mA}$, $R_{IN} = 100\text{ }\Omega$, $C_L = 15\text{ pF}$	-30	—	30	ns
Fall time	t_f	(Note 1)	Fig. 12.1.5	$I_F = 0 \rightarrow 14\text{ mA}$, $R_{IN} = 100\text{ }\Omega$, $C_L = 15\text{ pF}$	—	15	—	ns
Rise time	t_r	(Note 1)		$I_F = 14 \rightarrow 0\text{ mA}$, $R_{IN} = 100\text{ }\Omega$, $C_L = 15\text{ pF}$	—	15	—	ns
High-level common-mode transient immunity	CM_H		Fig. 12.1.6	$V_{CM} = 1000\text{ V}_{p-p}$, $I_F = 0\text{ mA}$, $V_{O(min)} = 2\text{ V}$, $V_{CC} = 3.3\text{ V}$, $T_a = 25\text{ }^{\circ}\text{C}$	± 20	± 25	—	kV/ μs
Low-level common-mode transient immunity	CM_L			$V_{CM} = 1000\text{ V}_{p-p}$, $I_F = 14\text{ mA}$, $V_{O(max)} = 0.4\text{ V}$, $V_{CC} = 3.3\text{ V}$, $T_a = 25\text{ }^{\circ}\text{C}$	± 20	± 25	—	kV/ μs

Note: All typical values are at $V_{CC} = 3.3\text{ V}$, $T_a = 25\text{ }^{\circ}\text{C}$.

Note: Each channel

Note 1: $f = 5\text{ MHz}$, duty = 50 %, input current $t_r = t_f$ = less than 5 ns, C_L is less than 15 pF which includes probe and stray wiring capacitance.

Note 2: The propagation delay skew, t_{psk} , is equal to the magnitude of the worst-case difference in t_{pHL} and/or t_{pLH} that will be seen between units at the same given conditions (supply voltage, input current, temperature, etc.).

11.2. Switching Characteristics (2) (Unless otherwise specified, $T_a = -40$ to $125\text{ }^\circ\text{C}$, $V_{CC} = 4.5$ to 5.5 V)

Characteristics	Symbol	Note	Test Circuit	Test Condition	Min	Typ.	Max	Unit
Propagation delay time (H/L)	t_{pHL}	(Note 1)	Fig. 12.1.5	$I_F = 0 \rightarrow 14\text{ mA}$, $R_{IN} = 100\text{ }\Omega$, $C_L = 15\text{ pF}$	—	33	45	ns
Propagation delay time (L/H)	t_{pLH}	(Note 1)		$I_F = 14 \rightarrow 0\text{ mA}$, $R_{IN} = 100\text{ }\Omega$, $C_L = 15\text{ pF}$	—	25	45	ns
Pulse width distortion	$ t_{pHL} - t_{pLH} $	(Note 1)		$I_F = 14\text{ mA}$, $R_{IN} = 100\text{ }\Omega$, $C_L = 15\text{ pF}$	—	8	25	ns
Propagation delay skew (device to device)	t_{psk}	(Note 1), (Note 2)		$I_F = 14\text{ mA}$, $R_{IN} = 100\text{ }\Omega$, $C_L = 15\text{ pF}$	-30	—	30	ns
Propagation delay time (H/L)	t_{pHL}	(Note 1)	Fig. 12.1.5	$I_F = 0 \rightarrow 6\text{ mA}$, $R_{IN} = 100\text{ }\Omega$, $C_L = 15\text{ pF}$	—	40	55	ns
Propagation delay time (L/H)	t_{pLH}	(Note 1)		$I_F = 6 \rightarrow 0\text{ mA}$, $R_{IN} = 100\text{ }\Omega$, $C_L = 15\text{ pF}$	—	28	55	ns
Pulse width distortion	$ t_{pHL} - t_{pLH} $	(Note 1)		$I_F = 6\text{ mA}$, $R_{IN} = 100\text{ }\Omega$, $C_L = 15\text{ pF}$	—	12	30	ns
Propagation delay skew (device to device)	t_{psk}	(Note 1), (Note 2)		$I_F = 6\text{ mA}$, $R_{IN} = 100\text{ }\Omega$, $C_L = 15\text{ pF}$	-30	—	30	ns
Fall time	t_f	(Note 1)	Fig. 12.1.5	$I_F = 0 \rightarrow 14\text{ mA}$, $R_{IN} = 100\text{ }\Omega$, $C_L = 15\text{ pF}$	—	15	—	ns
Rise time	t_r	(Note 1)		$I_F = 14 \rightarrow 0\text{ mA}$, $R_{IN} = 100\text{ }\Omega$, $C_L = 15\text{ pF}$	—	15	—	ns
High-level common-mode transient immunity	CM_H		Fig. 12.1.6	$V_{CM} = 1000\text{ V}_{p-p}$, $I_F = 0\text{ mA}$, $V_O(\text{min}) = 4\text{ V}$, $V_{CC} = 5\text{ V}$, $T_a = 25\text{ }^\circ\text{C}$	± 20	± 25	—	kV/ μs
Low-level common-mode transient immunity	CM_L			$V_{CM} = 1000\text{ V}_{p-p}$, $I_F = 14\text{ mA}$, $V_O(\text{max}) = 0.4\text{ V}$, $V_{CC} = 5\text{ V}$, $T_a = 25\text{ }^\circ\text{C}$	± 20	± 25	—	kV/ μs

Note: All typical values are at $V_{CC} = 5\text{ V}$, $T_a = 25\text{ }^\circ\text{C}$.

Note: Each channel

Note 1: $f = 5\text{ MHz}$, duty = 50 %, input current $t_r = t_f =$ less than 5 ns, C_L is less than 15 pF which includes probe and stray wiring capacitance.

Note 2: The propagation delay skew, t_{psk} , is equal to the magnitude of the worst-case difference in t_{pHL} and/or t_{pLH} that will be seen between units at the same given conditions (supply voltage, input current, temperature, etc.).

12. Test Circuits and Characteristics Curves

12.1. Test Circuits

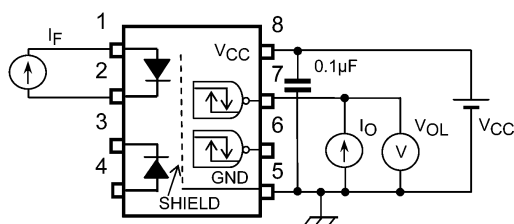


Fig. 12.1.1 VOL Test Circuit

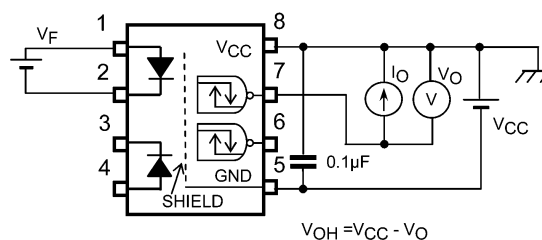


Fig. 12.1.2 VOH Test Circuit

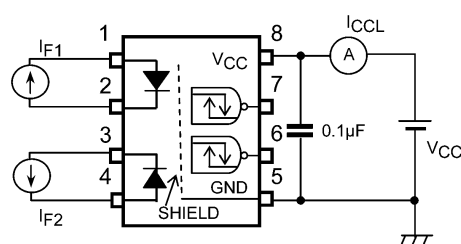


Fig. 12.1.3 ICCL Test Circuit

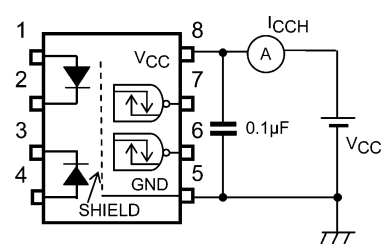
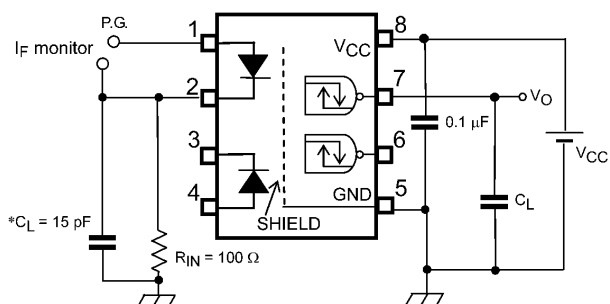


Fig. 12.1.4 ICCH Test Circuit

$I_F = 6/14 \text{ mA (P.G.)}$

($f = 5 \text{ MHz}$, duty = 50%, less than $t_r = t_f = 5 \text{ ns}$)



* C_L includes probe and stray capacitance.

P.G.: Pulse generator

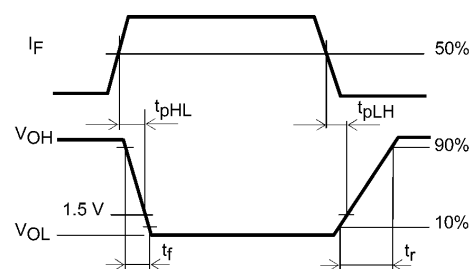
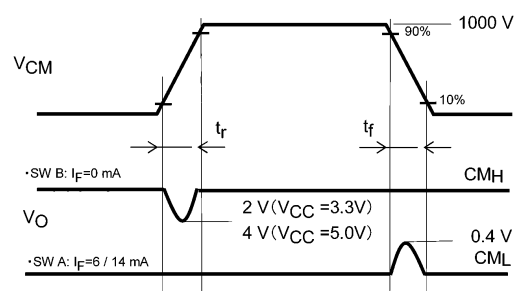
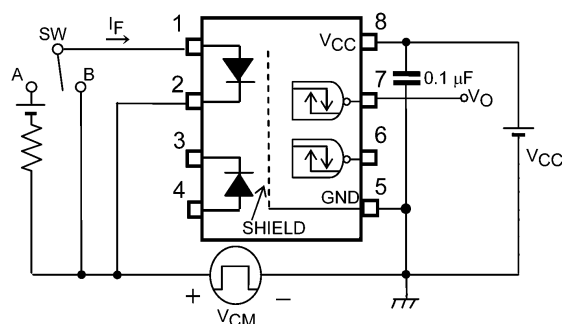


Fig. 12.1.5 Switching Time Test Circuit and Waveform



$$CML = \frac{800(V)}{t_r (\mu s)} \quad CMH = -\frac{800(V)}{t_f (\mu s)}$$

Fig. 12.1.6 Common-Mode Transient Immunity Test Circuit and Waveform

12.2. Characteristics Curves (Note)

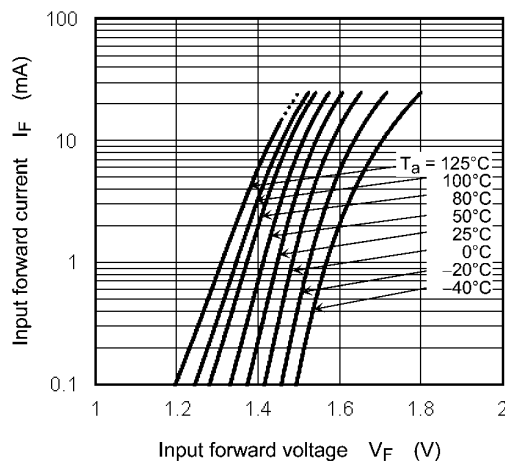


Fig. 12.2.1 $I_F - V_F$

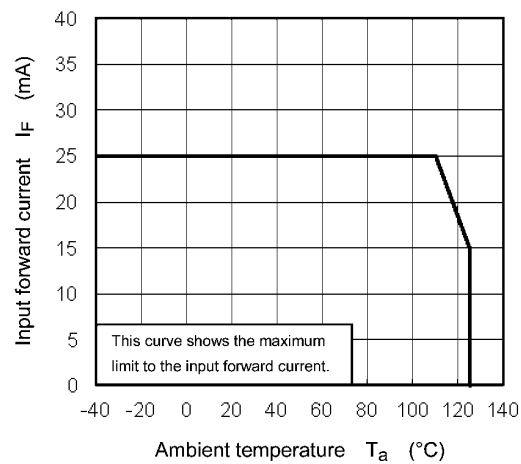


Fig. 12.2.2 $I_F - T_a$

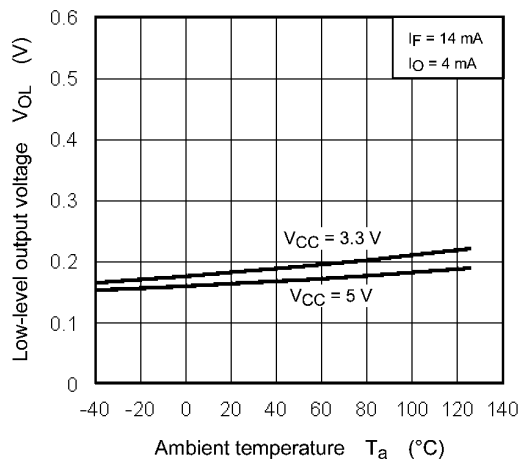


Fig. 12.2.3 $V_{OL} - T_a$

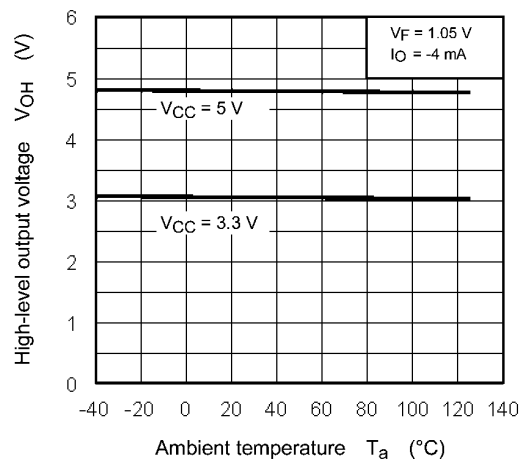


Fig. 12.2.4 $V_{OH} - T_a$

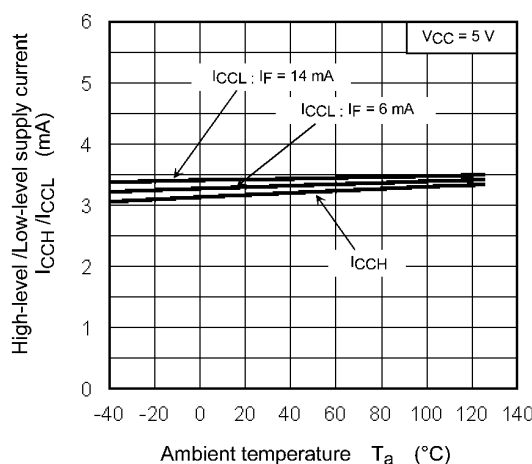


Fig. 12.2.5 $I_{CCL} - T_a$

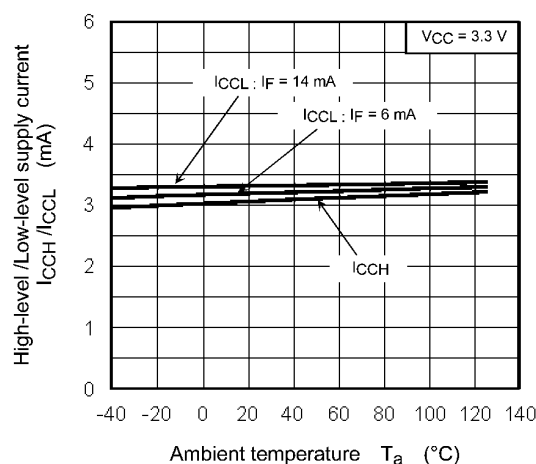


Fig. 12.2.6 $I_{CCH} - T_a$

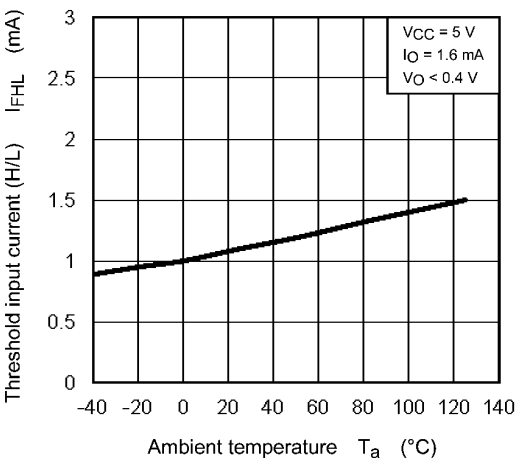


Fig. 12.2.7 $I_{FHL} - T_a$

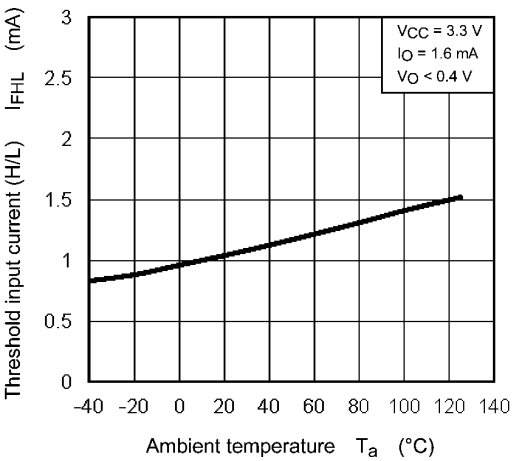


Fig. 12.2.8 $I_{FHL} - T_a$

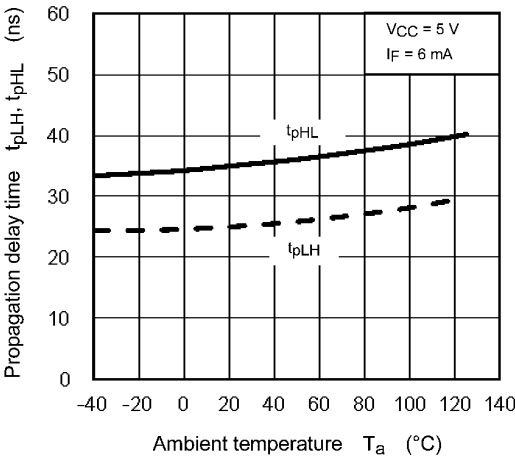


Fig. 12.2.9 $t_{pLH}, t_{pHL} - T_a$

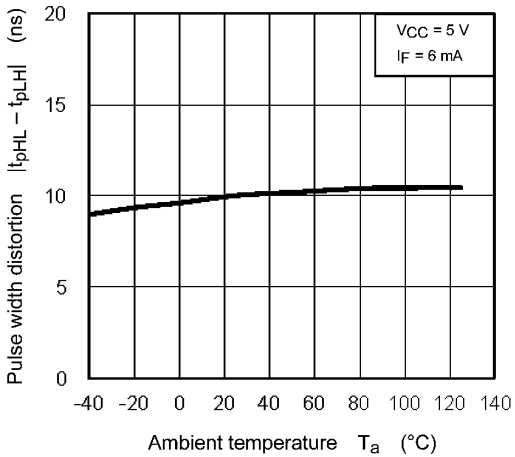


Fig. 12.2.10 $|t_{pHL} - t_{pLH}| - T_a$

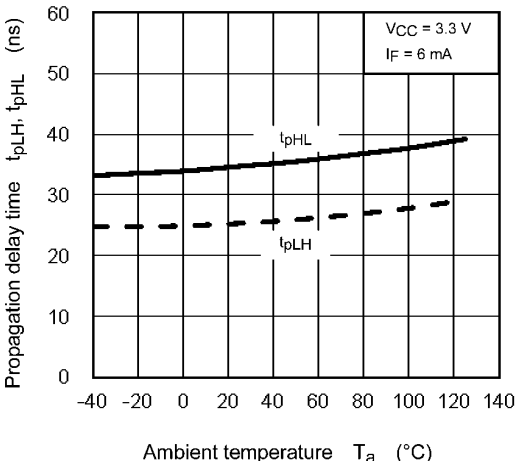


Fig. 12.2.11 $t_{pLH}, t_{pHL} - T_a$

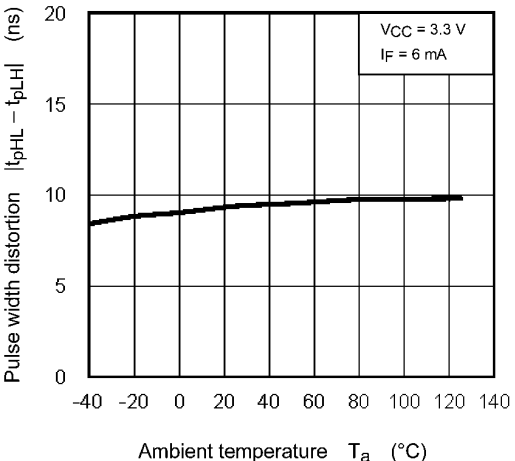


Fig. 12.2.12 $|t_{pHL} - t_{pLH}| - T_a$

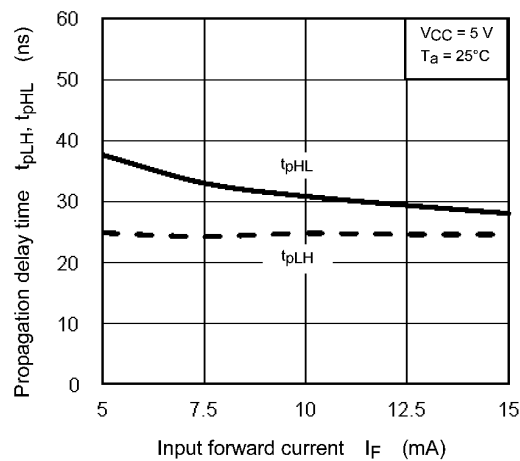


Fig. 12.2.13 $t_{pLH}, t_{pHL} - I_F$

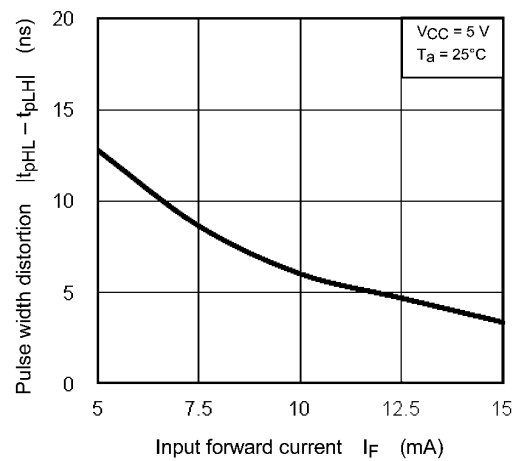


Fig. 12.2.14 $|t_{pHL} - t_{pLH}| - I_F$

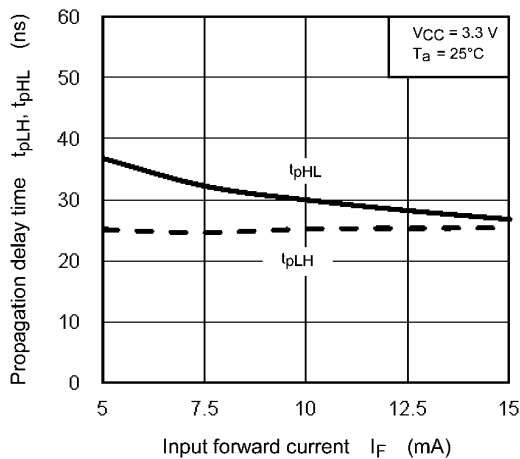


Fig. 12.2.15 $t_{pLH}, t_{pHL} - I_F$

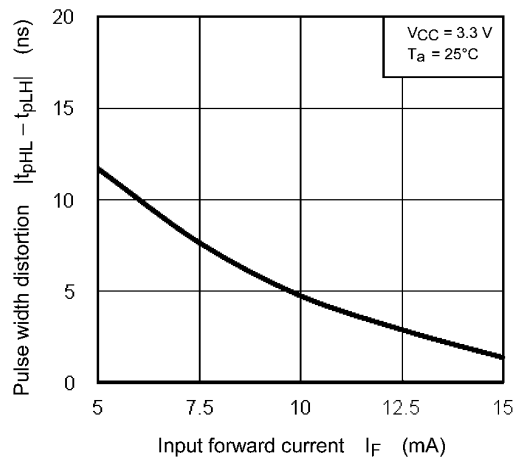


Fig. 12.2.16 $|t_{pHL} - t_{pLH}| - I_F$

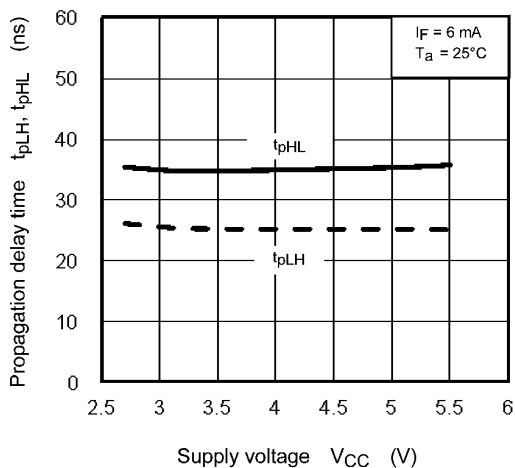


Fig. 12.2.17 $t_{pLH}, t_{pHL} - V_{CC}$

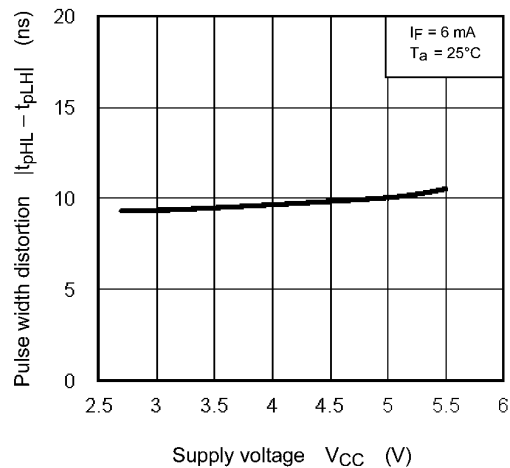
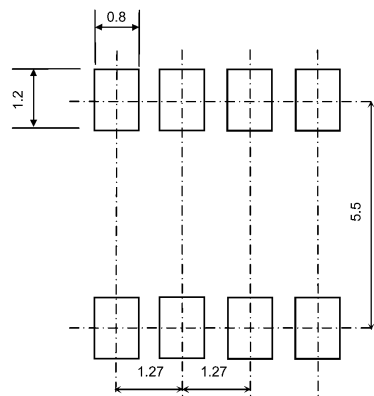


Fig. 12.2.18 $|t_{pHL} - t_{pLH}| - V_{CC}$

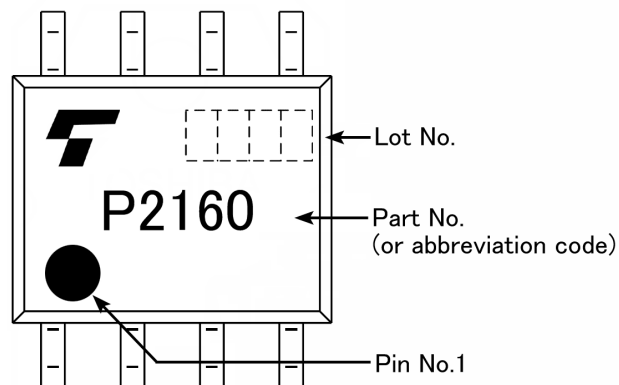
Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

14. Land Pattern Dimensions (for reference only)



Unit: mm

15. Marking



16. EN 60747-5-5 Option (V4) Specification

- Part number: TLP2160 (**Note 1**)
- The following part naming conventions are used for the devices that have been qualified according to option (V4) of EN 60747.

Example: TLP2160(V4-TP,F)

V4: EN 60747 option

TP: Tape type

F: [[G]]/RoHS COMPATIBLE (**Note 2**)

Note 1: Use TOSHIBA standard type number for safety standard application.

e.g., TLP2160(V4-TP,F) → TLP2160

Note 2: Please contact your Toshiba sales representative for details on environmental information such as the product's RoHS compatibility.

RoHS is the Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

Description	Symbol	Rating	Unit
Application classification			—
for rated mains voltage ≤ 150 Vrms for rated mains voltage ≤ 300 Vrms		I-IV I-III	—
Climatic classification		40 / 125 / 21	—
Pollution degree		2	—
Maximum operating insulation voltage	V_{IORM}	565	Vpeak
Input to output test voltage, Method A $V_{pr} = 1.6 \times V_{IORM}$, type and sample test $t_p = 10$ s, partial discharge < 5 pC	V_{pr}	904	Vpeak
Input to output test voltage, Method B $V_{pr} = 1.875 \times V_{IORM}$, 100 % production test $t_p = 1$ s, partial discharge < 5 pC	V_{pr}	1059	Vpeak
Highest permissible overvoltage (transient overvoltage, $t_{pr} = 60$ s)	V_{TR}	4000	Vpeak
Safety limiting values (max. permissible ratings in case of fault, also refer to thermal derating curve) current (input current I_F , $P_{SO} = 0$) power (output or total power dissipation) temperature	I_{Si} P_{SO} T_S	250 400 150	mA mW °C
Insulation resistance $V_{IO} = 500$ V, $T_a = 25$ °C $V_{IO} = 500$ V, $T_a = 100$ °C $V_{IO} = 500$ V, $T_a = T_S$	R_{Si}	$\geq 10^{12}$ $\geq 10^{11}$ $\geq 10^9$	Ω

Fig. 16.1 EN 60747 Isolation Characteristics

Minimum creepage distance	Cr	4.2 mm
Minimum clearance	Cl	4.2 mm
Minimum insulation thickness	ti	—
Comparative tracking index	CTI	175

Fig. 16.2 Insulation Related Specifications (Note)

Note: This photocoupler is suitable for **safe electrical isolation** only within the safety limit data.
Maintenance of the safety data shall be ensured by means of protective circuits.



Fig. 16.3 Marking on Packing

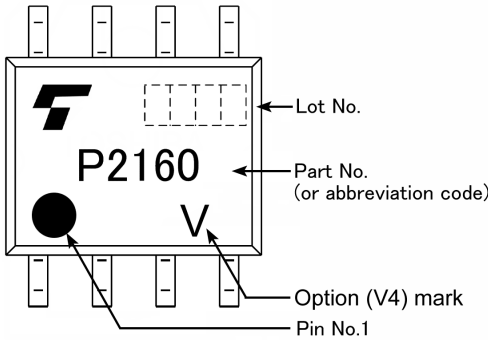
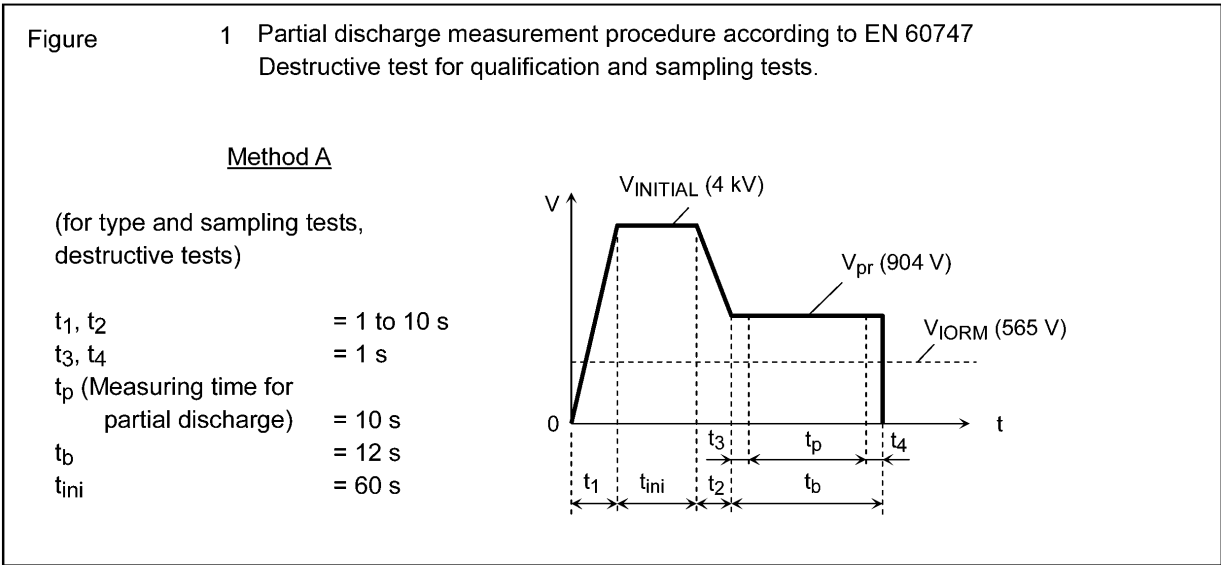


Fig. 16.4 Marking Example (Note)

Note: The above marking is applied to the photocouplers that have been qualified according to option (V4) of EN 60747.



17. Ordering Information

When placing an order, please specify the part number, tape type and quantity as shown in the following example.

Example) TLP2160 (TP,F) 2500 pcs

Part number: TLP2160

Tape type: TP

[[G]]/RoHS COMPATIBLE: F **(Note)**

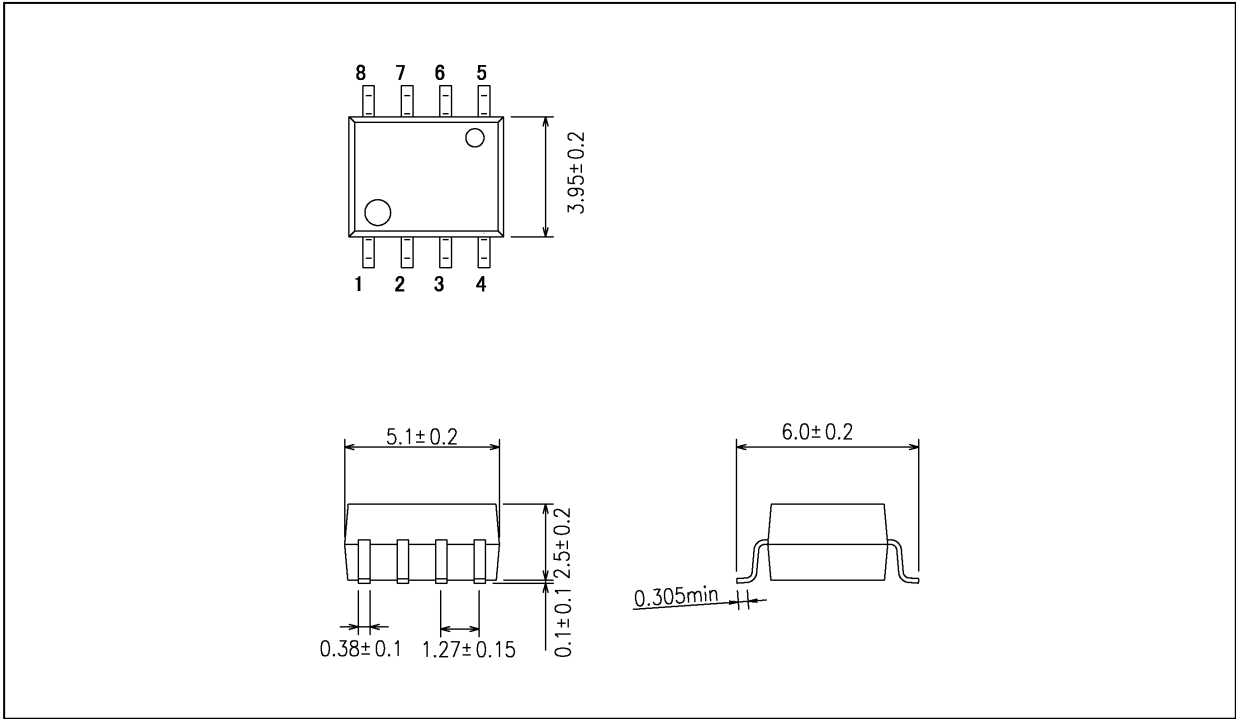
Quantity (must be a multiple of 2500)

Note : Please contact your Toshiba sales representative for details on environmental information such as the product's RoHS compatibility.

RoHS is the Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

Package Dimensions

Unit: mm



Weight: 0.11 g (typ.)

Package Name(s)
TOSHIBA: 11-5K1S

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